PD-96002B

# International **tor** Rectifier

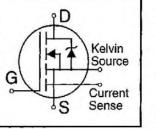
#### HEXFET<sup>®</sup> Power MOSFET

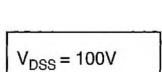
- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Current Sense
- 175°C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

#### Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The HEXSense device provides an accurate fraction of the drain current through the additional two leads to be used for control or protection of the device. These devices exhibit similar electrical and thermal characteristics as their IRF-series equivalent part numbers. The provision of a kelvin source connection effectively eliminates problems of common source inductance when the HEXSense is used as a fast, high-current switch in non current-sensing applications.

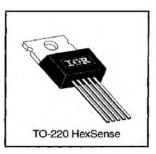




 $R_{DS(on)} = 0.077\Omega$ 

 $I_{\rm D} = 28A$ 

IRC540PbF



#### **Absolute Maximum Ratings**

|                                        | Parameter                                           | Max.                  | Units  |  |
|----------------------------------------|-----------------------------------------------------|-----------------------|--------|--|
| Ip @ Tc = 25°C                         | Continuous Drain Current, VGS @ 10 V                | 28                    |        |  |
| lp @ Tc = 100°C                        | Continuous Drain Current, VGs @ 10 V                | 20                    | A      |  |
| ĺDM                                    | Pulsed Drain Current ①                              | 110                   |        |  |
| P <sub>D</sub> @ T <sub>C</sub> = 25°C | Power Dissipation                                   | 150                   | W      |  |
|                                        | Linear Derating Factor                              | 1.0                   | . W/ºC |  |
| V <sub>GS</sub>                        | Gate-to-Source Voltage                              | ±20                   | V      |  |
| EAS                                    | Single Pulse Avalanche Energy @                     | 100                   | mJ     |  |
| AR                                     | Avalanche Current ①                                 | 28                    | A      |  |
| EAR                                    | Repetitive Avalanche Energy ①                       | 15                    | mJ     |  |
| dv/dt                                  | Peak Diode Recovery dv/dt ③                         | 5.5                   | V/ns   |  |
| Тј<br>Тета                             | Operating Junction and<br>Storage Temperature Range | -55 to +175           | °C     |  |
|                                        | Soldering Temperature, for 10 seconds               | 300 (1.6mm from case) |        |  |
|                                        | Mounting Torque, 6-32 or M3 screw                   | 10 lbf•in (1.1 N•m)   |        |  |

#### **Thermal Resistance**

|      | Parameter                           | Min. | Тур. | Max. | Units |
|------|-------------------------------------|------|------|------|-------|
| Rejc | Junction-to-Case                    |      | -    | 1.0  |       |
| Recs | Case-to-Sink, Flat, Greased Surface | -    | 0.50 | -    | °C/W  |
| Reja | Junction-to-Ambient                 |      | -    | 62   | 7     |

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|                 | Parameter                            | Min. | Тур. | Max.  | Units | Test Conditions                                                  |  |
|-----------------|--------------------------------------|------|------|-------|-------|------------------------------------------------------------------|--|
| V(BR)DSS        | Drain-to-Source Breakdown Voltage    | 100  | -    | -     | ۷     | V <sub>GS</sub> =0V, I <sub>D</sub> = 250µA                      |  |
| ΔV(BR)DSS/ΔTJ   | Breakdown Voltage Temp. Coefficient  | -    | 0.13 | -     | V/°C  | Reference to 25°C, ID= 1mA                                       |  |
| RDS(on)         | Static Drain-to-Source On-Resistance | -    | -    | 0.077 | Ω     | VGS=10V, ID=17A @                                                |  |
| VGS(th)         | Gate Threshold Voltage               | 2.0  | -    | 4.0   | V     | VDS=VGS, ID= 250µA                                               |  |
| g <sub>fs</sub> | Forward Transconductance             | 5.8  | -    | -     | S     | VDS=50V, ID=17A ④                                                |  |
| IDSS            |                                      | -    | -    | 25    | μA    | V <sub>DS</sub> =100V, V <sub>GS</sub> =0V                       |  |
|                 | Drain-to-Source Leakage Current      | -    | +    | 250   | μΑ    | V <sub>DS</sub> =80V, V <sub>GS</sub> =0V, T <sub>J</sub> =150°C |  |
| lass            | Gate-to-Source Forward Leakage       | -    | -    | 100   | nA    | V <sub>GS</sub> =20V                                             |  |
|                 | Gate-to-Source Reverse Leakage       | -    | -    | -100  | 11A   | V <sub>GS</sub> =-20V                                            |  |
| Qg              | Total Gate Charge                    | -    | -    | 69    |       | ID=29A                                                           |  |
| Q <sub>gs</sub> | Gate-to-Source Charge                | -    | -    | 13    | nC    | V <sub>DS</sub> =80V<br>V <sub>GS</sub> =10V See Fig. 6 and 13   |  |
| Qgd             | Gate-to-Drain ("Miller") Charge      | -    | -    | 37    |       |                                                                  |  |
| td(on)          | Turn-On Delay Time                   | -    | 13   | -     |       | V <sub>DD</sub> =50V                                             |  |
| tr              | Rise Time                            | -    | 77   | -     | ns    | ID=29A                                                           |  |
| td(off)         | Turn-Off Delay Time                  | -    | 40   | -     |       | R <sub>G</sub> =9.1Ω                                             |  |
| tr              | Fall Time                            | -    | 48   | -     |       | $R_D=1.7\Omega$ See Figure 10 ④                                  |  |
| LD              | Internal Drain Inductance            | -    | 4.5  | -     | nH    | Between lead,<br>6 mm (0.25in.)                                  |  |
| Ls              | Internal Source Inductance           | -    | 7.5  | -     |       | from package<br>and center of<br>die contact                     |  |
| Ciss            | Input Capacitance                    | -    | 1300 | -     |       | V <sub>GS</sub> =0V                                              |  |
| Coss            | Output Capacitance                   | -    | 630  | -     | pF    | V <sub>DS</sub> =25V                                             |  |
| Crss            | Reverse Transfer Capacitance         | -    | 130  | -     |       | f=1.0MHz See Figure 5                                            |  |
| r               | Current Sensing Ratio                | 2550 | -    | 2810  | -     | ID=29A, VGS=10V                                                  |  |
| Coss            | Output Capacitance of Sensing Cells  | -    | 9.0  | -     | pF    | VGS=0V, VDS= 25V, f=1.0MH                                        |  |

#### Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

#### **Source-Drain Ratings and Characteristics**

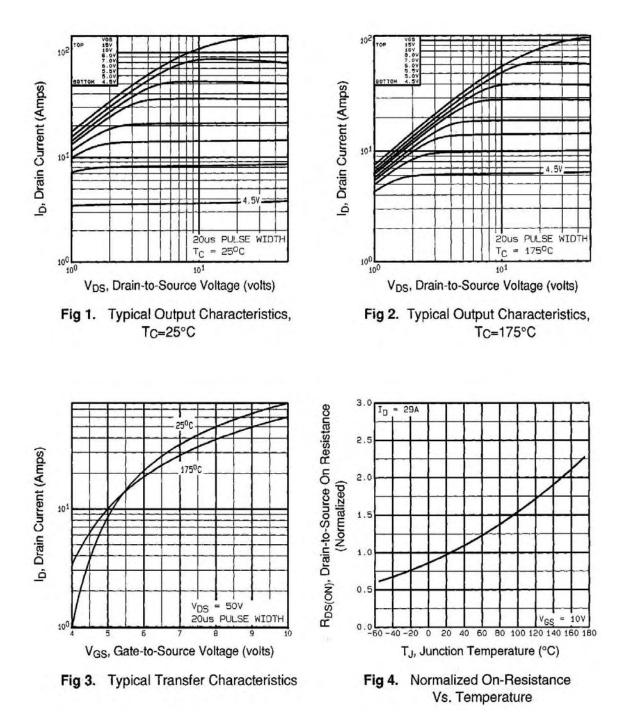
|     | Parameter                                 | Min.                                                                 | Тур. | Max. | Units | Test Conditions                 |
|-----|-------------------------------------------|----------------------------------------------------------------------|------|------|-------|---------------------------------|
| ls  | Continuous Source Current<br>(Body Diode) | -                                                                    | -    | 28   | A     | MOSFET symbol point showing the |
| ISM | Pulsed Source Current<br>(Body Diode) ①   | -                                                                    | -    | 110  |       | integral reverse G              |
| Vsp | Diode Forward Voltage                     | -                                                                    | -    | 2.5  | V     | TJ=25°C, IS=28A, VGS=0V @       |
| trr | Reverse Recovery Time                     | -                                                                    | 120  | 260  | ns    | T_J=25°C, I⊧=29A                |
| Qrr | Reverse Recovery Charge                   | -                                                                    | 0.52 | 1.2  | μC    | di/dt=100A/µs ④                 |
| ton | Forward Turn-On Time                      | Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+Lo) |      |      |       |                                 |

#### Notes:

 Repetitive rating; pulse width limited by max. junction temperature (See Figure 11) ② V<sub>DD</sub>=25V, starting T<sub>J</sub>=25°C, L=191µH R<sub>G</sub>=25Ω, I<sub>AS</sub>=28A (See Figure 12) ④ Pulse width ≤ 300 µs; duty cycle ≤2%.

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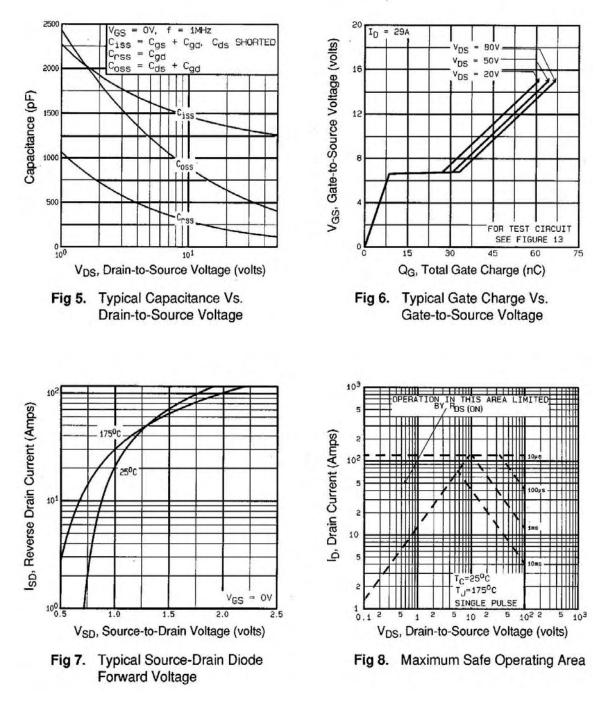
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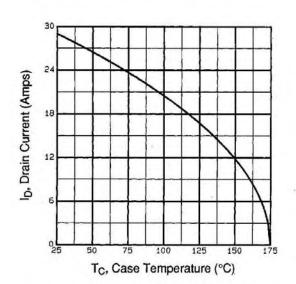
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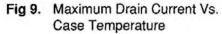
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**TOR** Rectifier



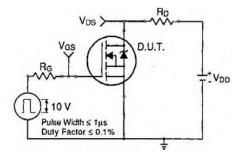


Fig 10a. Switching Time Test Circuit

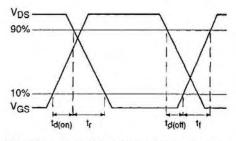


Fig 10b. Switching Time Waveforms

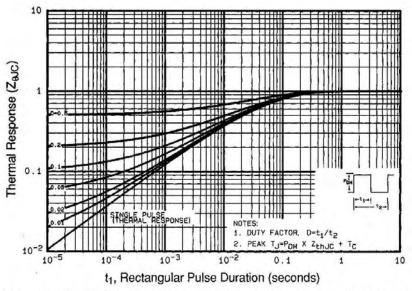


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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ID TOP 11A 20A 80TTOM 28A

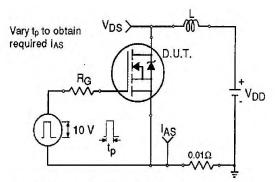


Fig 12a. Unclamped Inductive Test Circuit

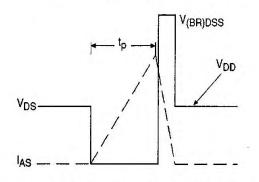


Fig 12b. Unclamped Inductive Waveforms

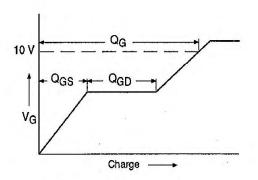


Fig 13a. Basic Gate Charge Waveform

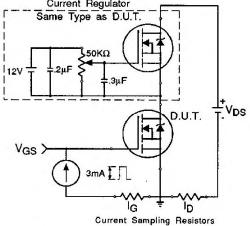
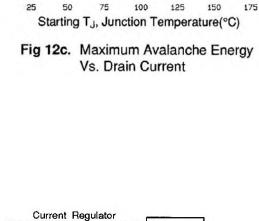


Fig 13b. Gate Charge Test Circuit

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300

250

200

150

100

50

0

VDD = 25V

EAS, Single Pulse Energy (mJ)

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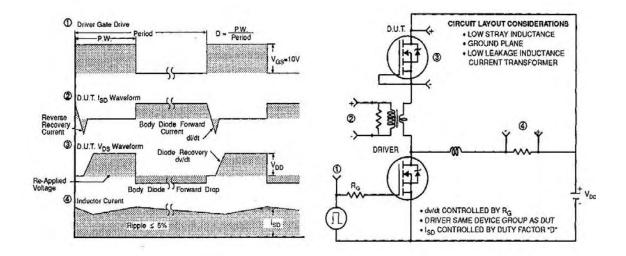
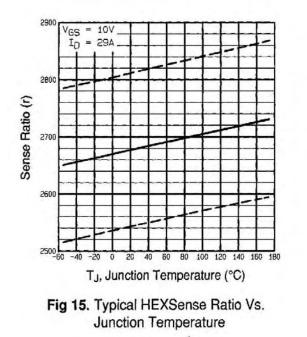
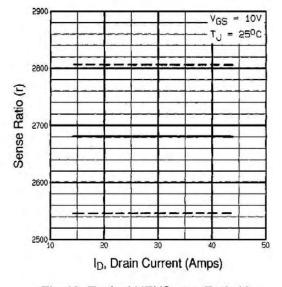
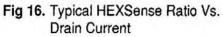


Fig 14. Peak Diode Recovery dv/dt Test Circuit

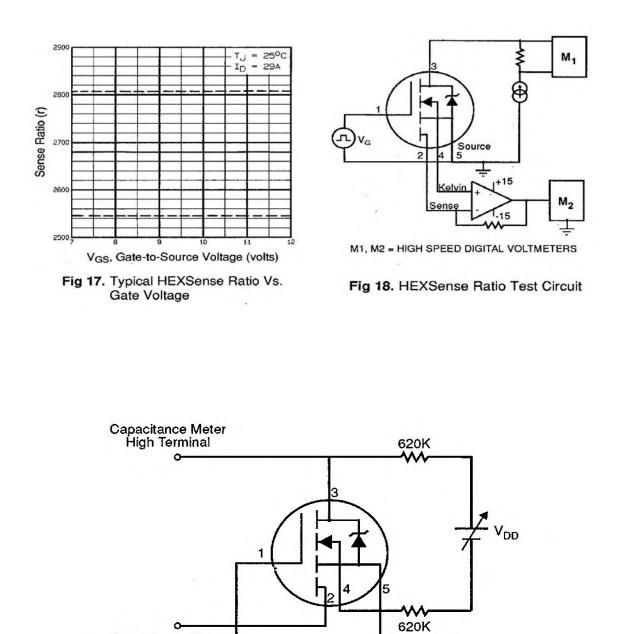






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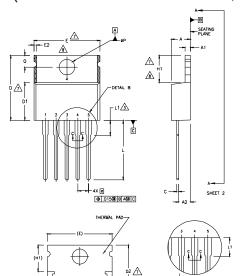


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Capacitance Meter Low Terminal

#### International **ICR** Rectifier HexsenseTO-220 5L Package Outline

( Dimensions are shown in millimeters (inches)



A

DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994.

2

- 3 4
- DIMENSIONING AND TOLERANCING PER ASIA TIA'S M- 1994. DIMENSIONS ARE SHOWN IN INCHES [MILLIMETERS]. LEAD DIMENSION AND FINISH UNCONTROLLED IN L1. DIMENSION D & E DO NOT INCLUDE MODI FLASH. MOLD FLASH SHALL NOT EXCEED. 005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.

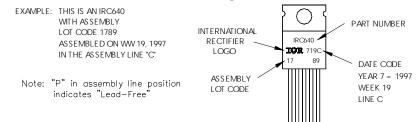
IRC540PbF

NOTES:

DIMENSION 51 & c1 APPLY TO BASE METAL ONLY. CONTROLLING DIMENSION : INCHES. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E,H1,D2 & E1 DIMENSION E2 X H1 DEFINE A ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED. 8

| SYMBOL | BOL MILLIMETERS |       | INC  |             |       |
|--------|-----------------|-------|------|-------------|-------|
|        | Min.            | MAX.  | MIN. | MAX.        | NOTES |
| A      | 3.56            | 4,82  | ,140 | .190        |       |
| A1     | 0.51            | 1.40  | .020 | .055        |       |
| A2     | 2.04            | 2.92  | .080 | .115        |       |
| b      | 0.64            | 0.88  | .025 | .035        |       |
| b1     | 0.64            | 0.84  | .025 | .033        | 5     |
| с      | 0.36            | 0.61  | .014 | .024        |       |
| c1     | 0.36            | 0.56  | .014 | .022        | 5     |
|        |                 |       |      |             |       |
| D      | 14.22           | 16.51 | .560 | .650        | 4     |
| D1     | 8.38            | 9.02  | .330 | .355        |       |
| D2     | 12.19           | 12.88 | .480 | .507        | 7     |
| E      | 9.66            | 10,66 | .380 | .420        | 4,7   |
| E1     | 8,38            | 8.89  | .330 | .350<br>BSC | 7     |
| е      | 1,70            | BSC   | .067 |             |       |
| H1     | 5.85            | 6,55  | .230 | .270        | 7,8   |
| L      | 13.47           | 14.09 | .530 | .555        |       |
| L1     | -               | 6.35  | -    | .250        | 3     |
| øP     | 3.54            | 4.08  | .139 | .161        |       |
| Q      | 2.54            | 3.42  | .100 | .135        |       |
| ø      | 90'-            | -93*  | 90'- | -93*        |       |
|        |                 |       | [    |             |       |
|        |                 |       | [    |             |       |
|        |                 |       |      |             |       |
|        |                 |       |      |             |       |

#### Hexsense TO-220 5L Part Marking Information



Data and specifications subject to change without notice.

### International **ICR** Rectifier

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